

## General Description

The WSP4620 is the highest performance trench N-ch and P-ch MOSFETs with extreme high cell density , which provide excellent RDSON and gate charge for most of the synchronous buck converter applications .

The WSP4620 meet the RoHS and Green Product requirement 100% EAS guaranteed with full function reliability approved.

## Features

- Advanced high cell density Trench technology
- Super Low Gate Charge
- Excellent CdV/dt effect decline
- 100% EAS Guaranteed
- Green Device Available

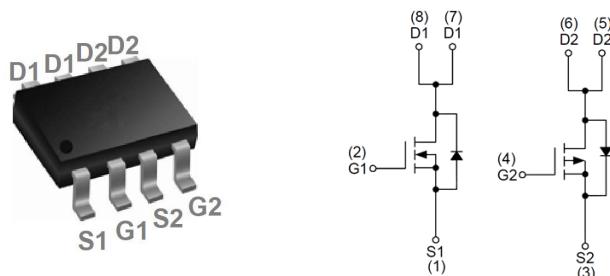
## Product Summary

| BVDSS | RDS(on) | ID    |
|-------|---------|-------|
| 30V   | 18mΩ    | 8.8A  |
| -30V  | 22mΩ    | -8.6A |

## Applications

- High Frequency Point-of-Load Synchronous Buck Converter for MB/NB/UMPC/VGA
- Networking DC-DC Power System
- CCFL Back-light Inverter

## SOP-8 Pin Configuration



## Absolute Maximum Ratings

| Symbol                                | Parameter  | Rating     |            | Units |
|---------------------------------------|--|------------|------------|-------|
|                                       |  | N-Ch       | P-Ch       |       |
| V <sub>DS</sub>                       | Drain-Source Voltage   | 30         | -30        | V     |
| V <sub>GS</sub>                       | Gate-Source Voltage  | ±20        | ±20        | V     |
| I <sub>D</sub> @T <sub>C</sub> =25°C  | Continuous Drain Current, V <sub>GS</sub> @ 10V <sup>1</sup> | 8.8        | -8.6       | A     |
| I <sub>D</sub> @T <sub>C</sub> =100°C | Continuous Drain Current, V <sub>GS</sub> @ 10V <sup>1</sup> | 6.8        | -6.7       | A     |
| I <sub>DM</sub>                       | Pulsed Drain Current <sup>2</sup>                            | 17.5       | -17        | A     |
| EAS                                   | Single Pulse Avalanche Energy <sup>3</sup>                   | 72         | 70         | mJ    |
| I <sub>AS</sub>                       | Avalanche Current  | 26         | -26.5      | A     |
| P <sub>D</sub> @T <sub>C</sub> =25°C  | Total Power Dissipation <sup>4</sup>                         | 3.5        | 3.5        | W     |
| T <sub>STG</sub>                      | Storage Temperature Range                                    | -55 to 150 | -55 to 150 | °C    |
| T <sub>J</sub>                        | Operating Junction Temperature Range                         | -55 to 150 | -55 to 150 | °C    |

## Thermal Data

| Symbol           | Parameter  | Typ. | Max. | Unit |
|------------------|--|------|------|------|
| R <sub>θJA</sub> | Thermal Resistance Junction-Ambient <sup>1</sup> | ---  | 85   | °C/W |
| R <sub>θJC</sub> | Thermal Resistance Junction-Case <sup>1</sup>    | ---  | 36   | °C/W |

**Electrical Characteristics ( $T_J=25^\circ C$ , unless otherwise noted)**

| Symbol                       | Parameter                                      | Conditions                              | Min. | Typ.  | Max.      | Unit          |
|------------------------------|--|---|------|-------|-----------|---------------|
| $BV_{DSS}$                   | Drain-Source Breakdown Voltage                 | $V_{GS}=0V, I_D=250\mu A$               | 30   | ---   | ---       | V             |
| $\Delta BV_{DSS}/\Delta T_J$ | BVDSS Temperature Coefficient                  | Reference to $25^\circ C, I_D=1mA$      | ---  | 0.034 | ---       | $V/^\circ C$  |
| $R_{DS(ON)}$                 | Static Drain-Source On-Resistance <sup>2</sup> | $V_{GS}=10V, I_D=8A$                    | ---  | 18    | 24        | $m\Omega$     |
|                              |  | $V_{GS}=4.5V, I_D=6A$                   | ---  | 25    | 32        |               |
| $V_{GS(th)}$                 | Gate Threshold Voltage                         | $V_{GS}=V_{DS}, I_D=250\mu A$           | 1.0  | 1.5   | 2.5       | V             |
| $\Delta V_{GS(th)}$          | $V_{GS(th)}$ Temperature Coefficient           |   | ---  | -5.64 | ---       | $mV/^\circ C$ |
| $I_{DSS}$                    | Drain-Source Leakage Current                   | $V_{DS}=20V, V_{GS}=0V, T_J=25^\circ C$ | ---  | ---   | 1         | $\mu A$       |
|                              |  | $V_{DS}=20V, V_{GS}=0V, T_J=55^\circ C$ | ---  | ---   | 5         |               |
| $I_{GSS}$                    | Gate-Source Leakage Current                    | $V_{GS}=\pm 20V, V_{DS}=0V$             | ---  | ---   | $\pm 100$ | nA            |
| $g_{fs}$                     | Forward Transconductance                       | $V_{DS}=5V, I_D=8A$                     | ---  | 7     | ---       | S             |
| $R_g$                        | Gate Resistance                                | $V_{DS}=0V, V_{GS}=0V, f=1MHz$          | ---  | 2.5   | 5         | $\Omega$      |
| $Q_g$                        | Total Gate Charge (4.5V)                       | $V_{DS}=20V, V_{GS}=4.5V, I_D=8A$       | ---  | 6     | ---       | nC            |
| $Q_{gs}$                     | Gate-Source Charge                             |   | ---  | 2.5   | ---       |               |
| $Q_{gd}$                     | Gate-Drain Charge                              |   | ---  | 2.1   | ---       |               |
| $T_{d(on)}$                  | Turn-On Delay Time                             | $V_{DD}=12V, V_{GS}=10V, R_G=3.3\Omega$ | ---  | 2.4   | ---       | ns            |
| $T_r$                        | Rise Time                                      |   | ---  | 7.8   | ---       |               |
| $T_{d(off)}$                 | Turn-Off Delay Time                            |   | ---  | 22    | ---       |               |
| $T_f$                        | Fall Time                                      |   | ---  | 4     | ---       |               |
| $C_{iss}$                    | Input Capacitance                              | $V_{DS}=15V, V_{GS}=0V, f=1MHz$         | ---  | 572   | ---       | pF            |
| $C_{oss}$                    | Output Capacitance                             |   | ---  | 81    | ---       |               |
| $C_{rss}$                    | Reverse Transfer Capacitance                   |   | ---  | 65    | ---       |               |

**Guaranteed Avalanche Characteristics**

| Symbol | Parameter                                  | Conditions                        | Min. | Typ. | Max. | Unit |
|--------|--|-----------------------------------|------|------|------|------|
| EAS    | Single Pulse Avalanche Energy <sup>5</sup> | $V_{DD}=25V, L=0.1mH, I_{AS}=20A$ | 45   | ---  | ---  | mJ   |

**Diode Characteristics**

| Symbol   | Parameter                                | Conditions                          | Min. | Typ. | Max. | Unit |
|----------|--|-------------------------------------|------|------|------|------|
| $I_s$    | Continuous Source Current <sup>1,6</sup> | $V_G=V_D=0V$ , Force Current        | ---  | ---  | 9.0  | A    |
| $I_{SM}$ | Pulsed Source Current <sup>2,6</sup>     |                                     | ---  | ---  | 17.5 | A    |
| $V_{SD}$ | Diode Forward Voltage <sup>2</sup>       | $V_{GS}=0V, I_s=1A, T_J=25^\circ C$ | ---  | ---  | 1.2  | V    |

Note :

- 1.The data tested by surface mounted on a 1 inch<sup>2</sup> FR-4 board with 2OZ copper,t<10sec.
- 2.The data tested by pulsed , pulse width  $\leq 300\mu s$  , duty cycle  $\leq 2\%$
- 3.The EAS data shows Max. rating . The test condition is  $V_{DD}=25V, V_{GS}=10V, L=0.1mH, I_{AS}=20A$
- 4.The power dissipation is limited by  $150^\circ C$  junction temperature
- 5.The Min. value is 100% EAS tested guarantee.
- 6.The data is theoretically the same as  $I_D$  and  $I_{DM}$  , in real applications , should be limited by total power dissipation.

**P-Channel Electrical Characteristics ( $T_J=25^\circ C$ , unless otherwise noted)**

| Symbol                       | Parameter                                      | Conditions   | Min. | Typ.  | Max.      | Unit          |
|------------------------------|--|--|------|-------|-----------|---------------|
| $BV_{DSS}$                   | Drain-Source Breakdown Voltage                 | $V_{GS}=0V, I_D=-250\mu A$                         | -30  | ---   | ---       | V             |
| $\Delta BV_{DSS}/\Delta T_J$ | $BV_{DSS}$ Temperature Coefficient             | Reference to $25^\circ C, I_D=-1mA$                | ---  | -0.02 | ---       | V/ $^\circ C$ |
| $R_{DS(ON)}$                 | Static Drain-Source On-Resistance <sup>2</sup> | $V_{GS}=-10V, I_D=-6A$                             | ---  | 22    | 32        | $m\Omega$     |
|                              |  | $V_{GS}=-4.5V, I_D=-3A$                            | ---  | 32    | 45        |               |
| $V_{GS(th)}$                 | Gate Threshold Voltage                         | $V_{GS}=V_{DS}, I_D=-250\mu A$                     | -1.0 | -1.6  | -2.5      | V             |
| $\Delta V_{GS(th)}$          | $V_{GS(th)}$ Temperature Coefficient           |  | ---  | 3.72  | ---       | $mV/^\circ C$ |
| $I_{DSS}$                    | Drain-Source Leakage Current                   | $V_{DS}=-20V, V_{GS}=0V, T_J=25^\circ C$           | ---  | ---   | 1         | $\mu A$       |
|                              |  | $V_{DS}=-20V, V_{GS}=0V, T_J=55^\circ C$           | ---  | ---   | 5         |               |
| $I_{GSS}$                    | Gate-Source Leakage Current                    | $V_{GS}=\pm 20V, V_{DS}=0V$                        | ---  | ---   | $\pm 100$ | nA            |
| $gfs$                        | Forward Transconductance                       | $V_{DS}=-5V, I_D=-8A$                              | ---  | 13    | ---       | S             |
| $Q_g$                        | Total Gate Charge (-4.5V)                      | $V_{DS}=-15V, V_{GS}=-4.5V, I_D=-1A$               | ---  | 11.5  | ---       | $nC$          |
| $Q_{gs}$                     | Gate-Source Charge                             |  | ---  | 3.5   | ---       |               |
| $Q_{gd}$                     | Gate-Drain Charge                              |  | ---  | 3.3   | ---       |               |
| $T_{d(on)}$                  | Turn-On Delay Time                             | $V_{DD}=-15V, V_{GS}=-10V, R_G=3.3\Omega, I_D=-1A$ | ---  | 22    | ---       | $ns$          |
| $T_r$                        | Rise Time                                      |  | ---  | 15.7  | ---       |               |
| $T_{d(off)}$                 | Turn-Off Delay Time                            |  | ---  | 59    | ---       |               |
| $T_f$                        | Fall Time                                      |  | ---  | 5.5   | ---       |               |
| $C_{iss}$                    | Input Capacitance                              | $V_{DS}=-15V, V_{GS}=0V, f=1MHz$                   | ---  | 1415  | ---       | $pF$          |
| $C_{oss}$                    | Output Capacitance                             |  | ---  | 134   | ---       |               |
| $C_{rss}$                    | Reverse Transfer Capacitance                   |  | ---  | 102   | ---       |               |

**Guaranteed Avalanche Characteristics**

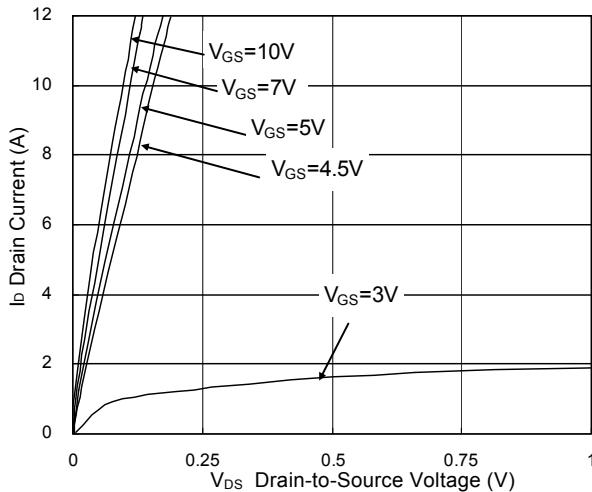
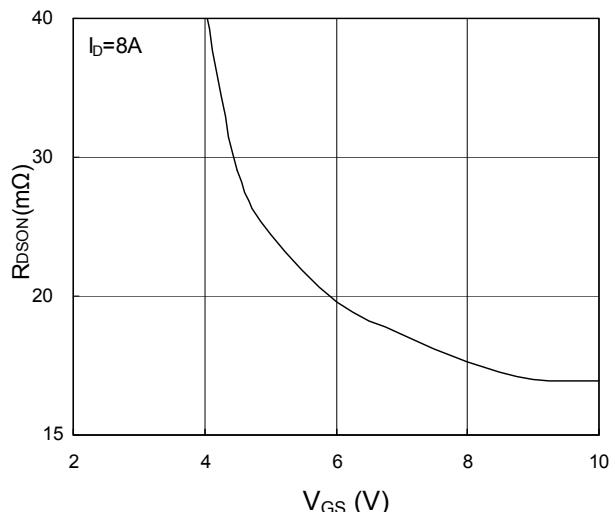
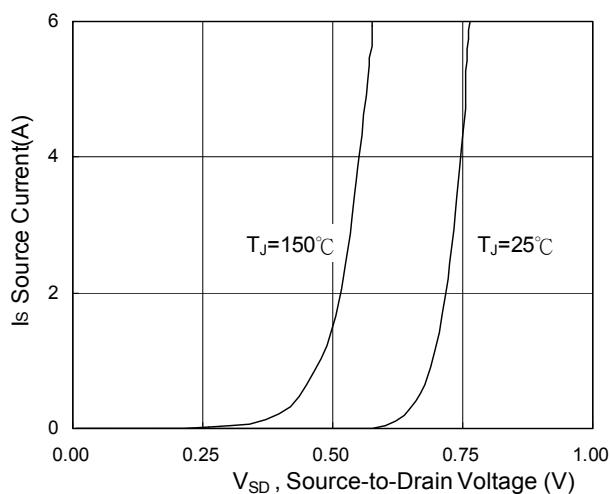
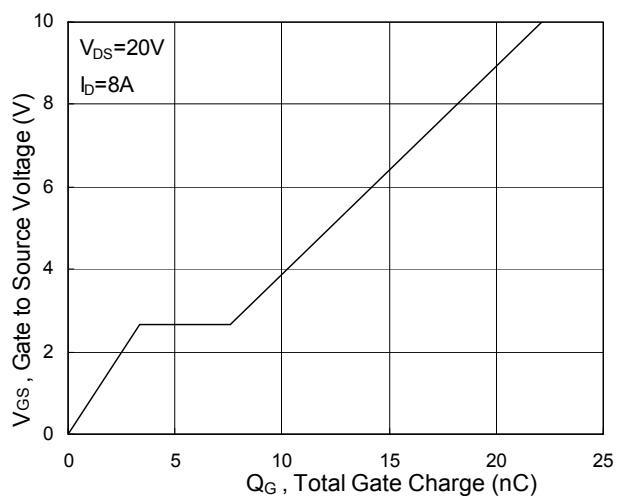
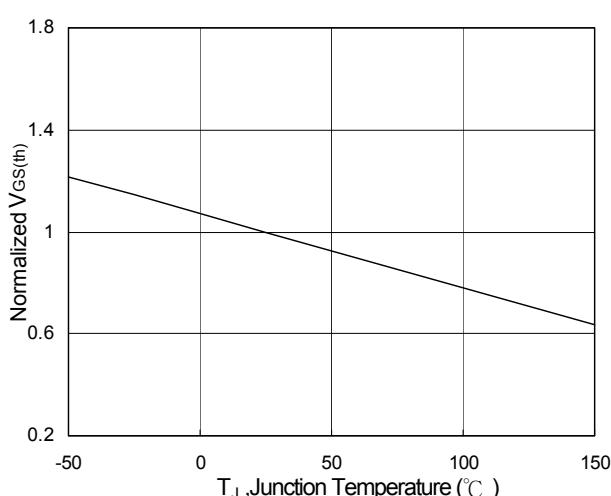
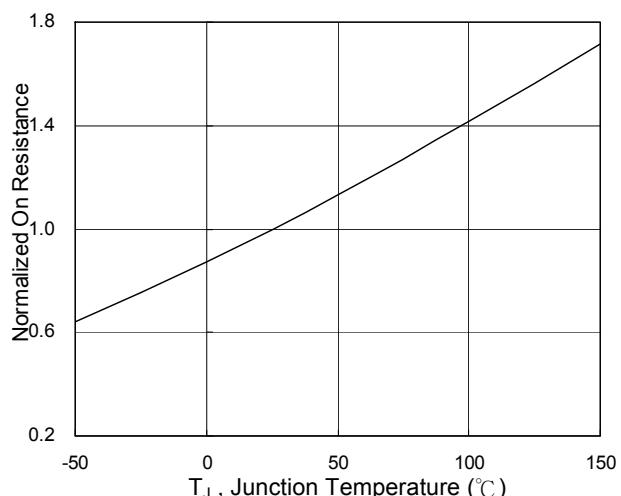
| Symbol | Parameter                                  | Conditions                          | Min. | Typ. | Max. | Unit |
|--------|--|-------------------------------------|------|------|------|------|
| EAS    | Single Pulse Avalanche Energy <sup>5</sup> | $V_{DD}=-25V, L=0.1mH, I_{AS}=-20A$ | 37   | ---  | ---  | mJ   |

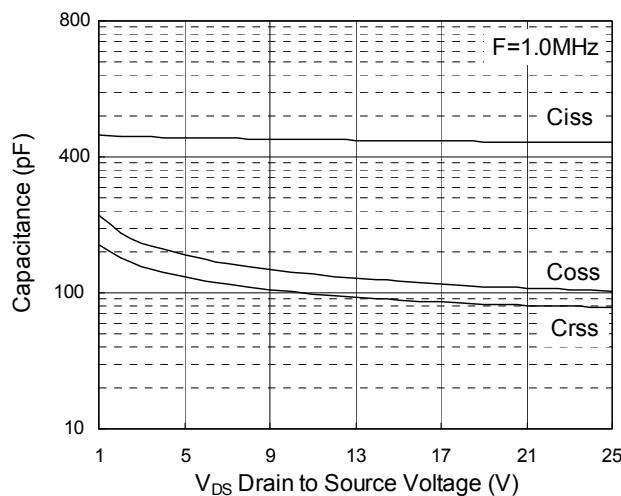
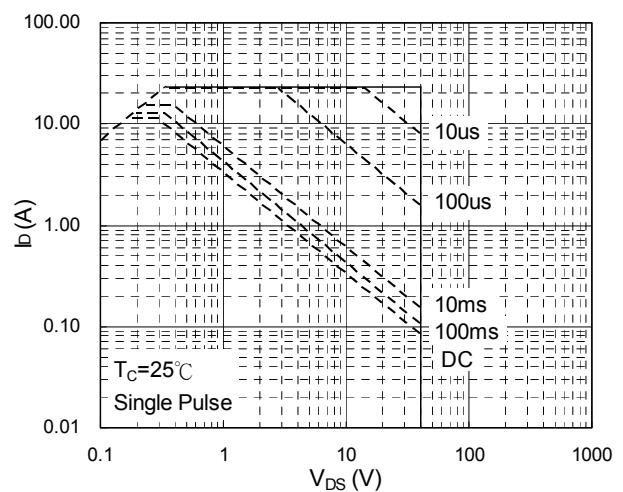
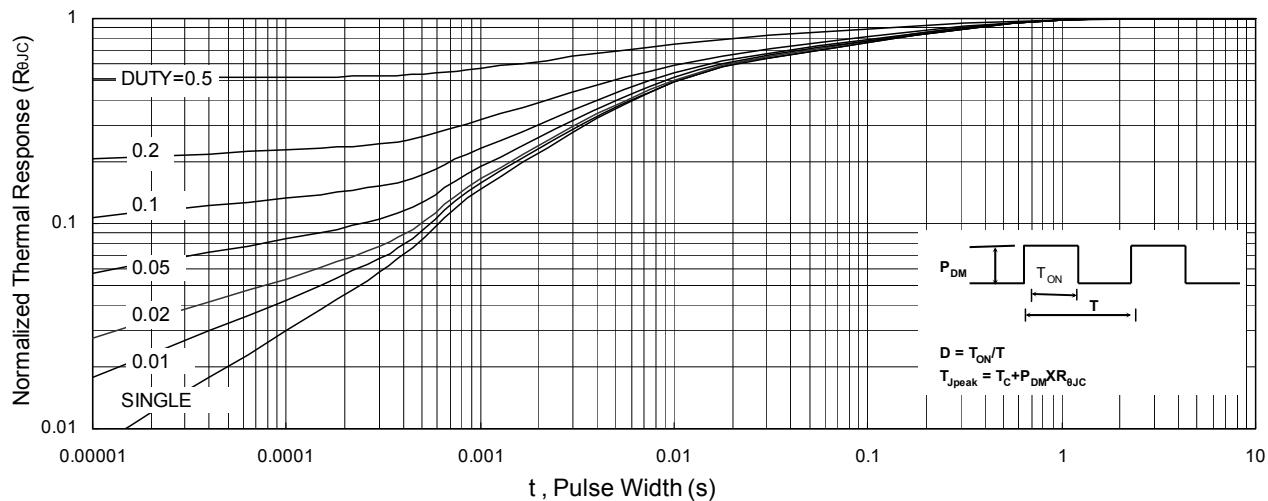
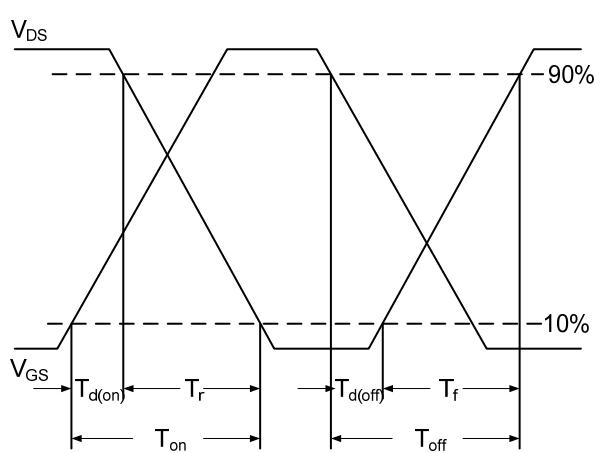
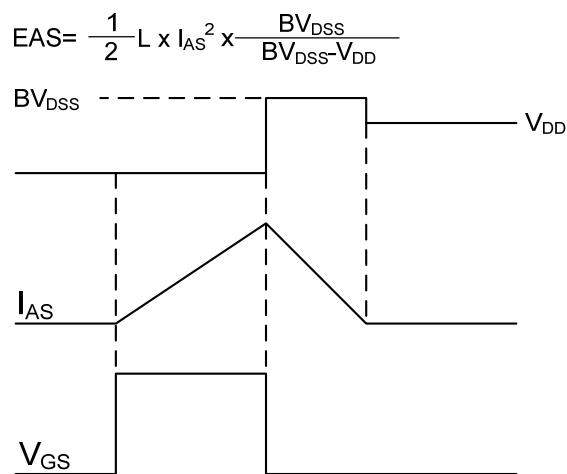
**Diode Characteristics**

| Symbol   | Parameter                                | Conditions                           | Min. | Typ. | Max. | Unit |
|----------|--|--------------------------------------|------|------|------|------|
| $I_s$    | Continuous Source Current <sup>1,6</sup> | $V_G=V_D=0V$ , Force Current         | ---  | ---  | -8.6 | A    |
| $I_{SM}$ | Pulsed Source Current <sup>2,6</sup>     |                                      | ---  | ---  | -17  | A    |
| $V_{SD}$ | Diode Forward Voltage <sup>2</sup>       | $V_{GS}=0V, I_s=-1A, T_J=25^\circ C$ | ---  | ---  | -1.2 | V    |

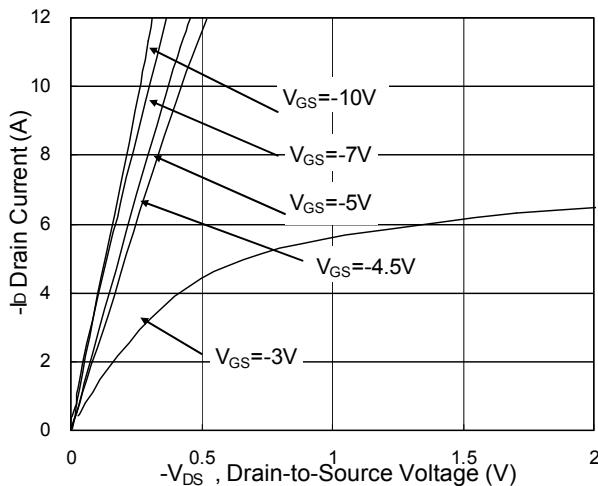
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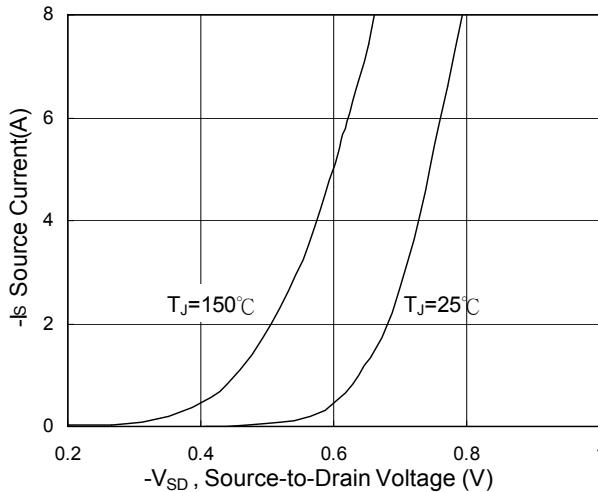
**N-Channel Typical Characteristics**

**Fig.1 Typical Output Characteristics**

**Fig.2 On-Resistance vs. G-S Voltage**

**Fig.3 Forward Characteristics of Reverse**

**Fig.4 Gate-Charge Characteristics**

**Fig.5 Normalized  $V_{GS(th)}$  vs.  $T_J$** 

**Fig.6 Normalized  $R_{DSON}$  vs.  $T_J$**


**Fig.7 Capacitance**

**Fig.8 Safe Operating Area**

**Fig.9 Normalized Maximum Transient Thermal Impedance**

**Fig.10 Switching Time Waveform**

**Fig.11 Unclamped Inductive Switching Wave**

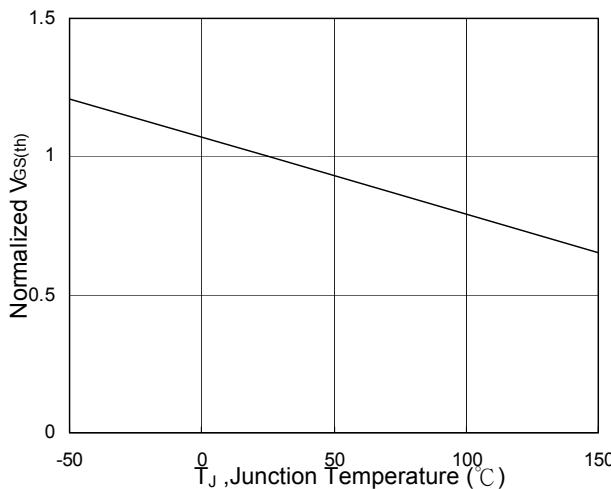
### P-Channel Typical Characteristics



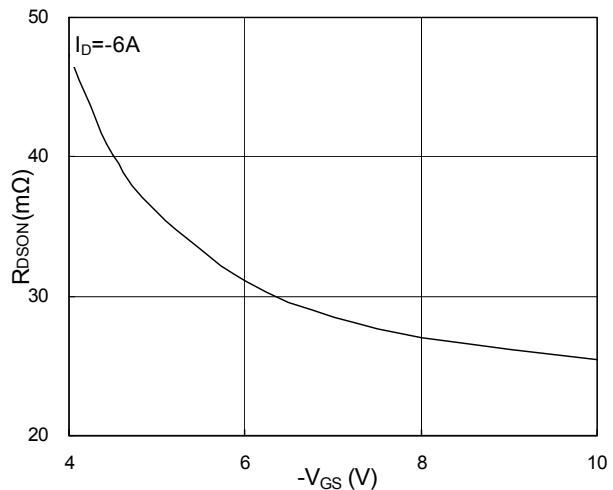
**Fig.1 Typical Output Characteristics**



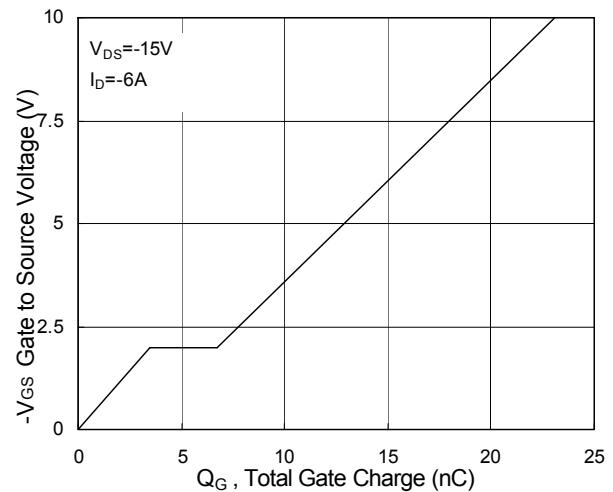
**Fig.3 Forward Characteristics of Reverse**



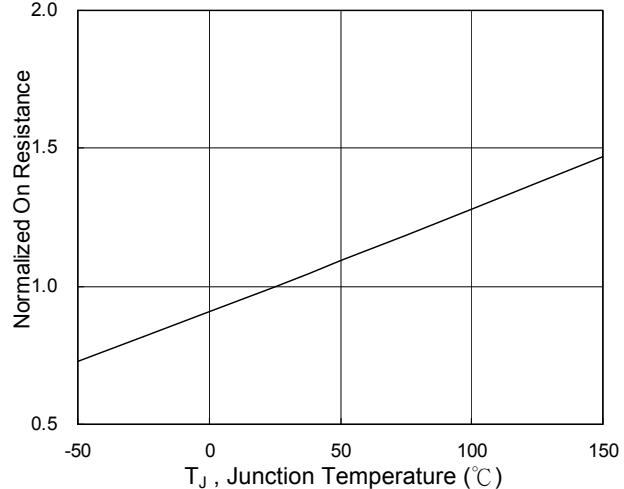
**Fig.5 Normalized  $V_{GS(th)}$  v.s  $T_J$**



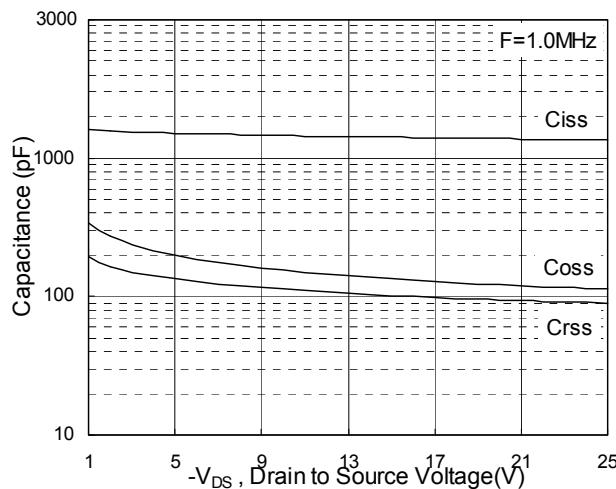
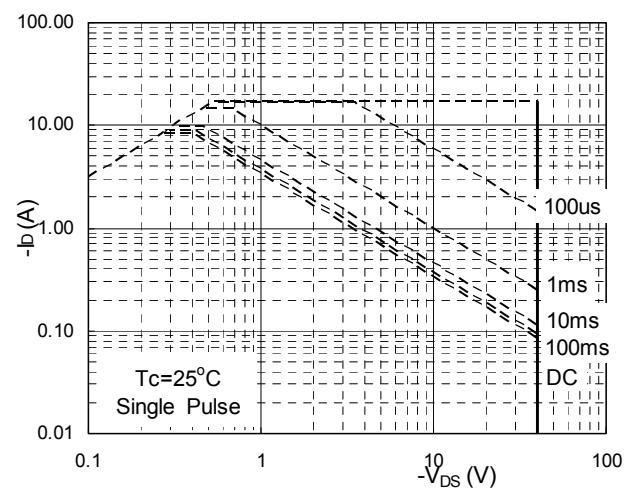
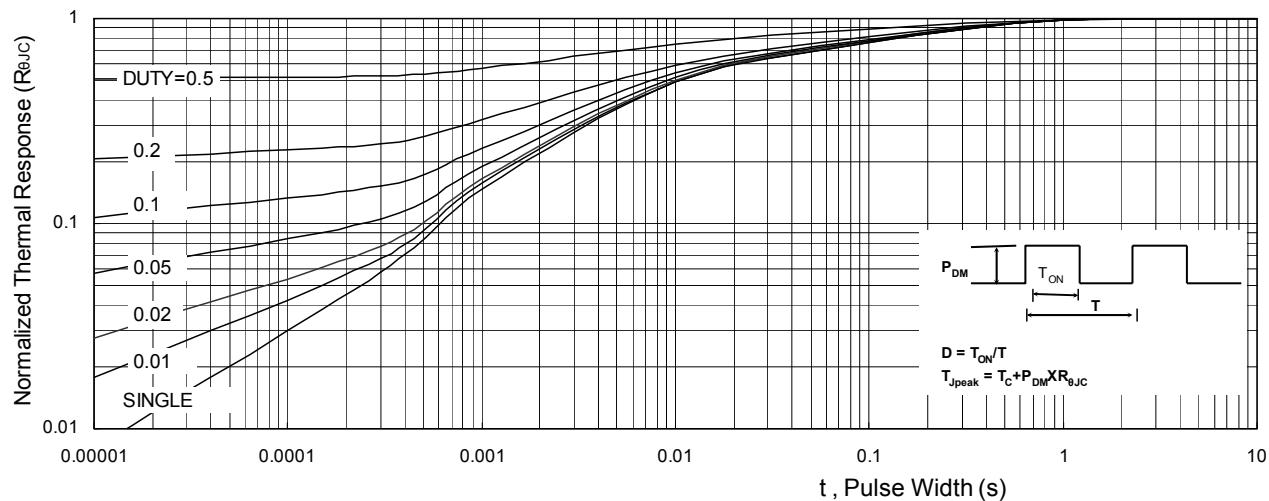
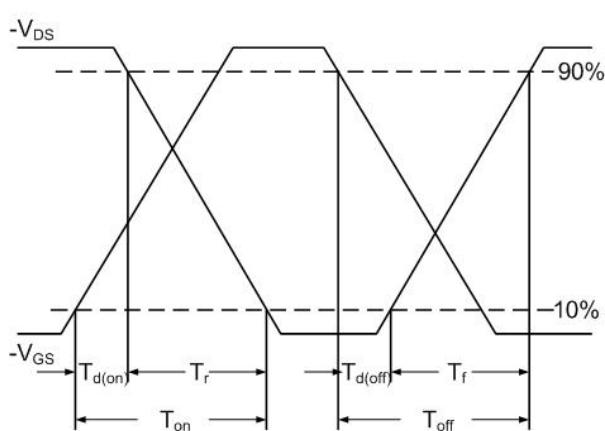
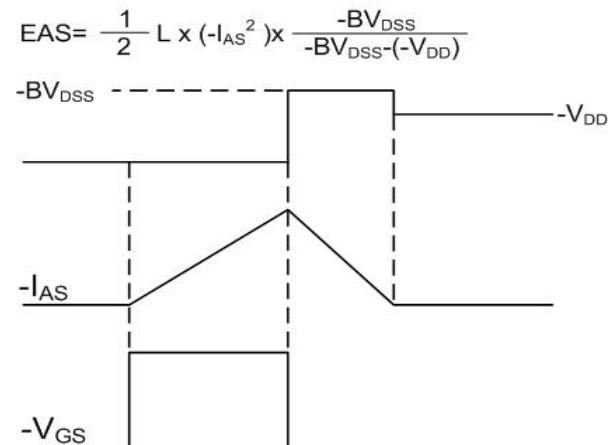
**Fig.2 On-Resistance v.s Gate-Source**



**Fig.4 Gate-Charge Characteristics**



**Fig.6 Normalized  $R_{DS(on)}$  v.s  $T_J$**


**Fig.7 Capacitance**

**Fig.8 Safe Operating Area**

**Fig.9 Normalized Maximum Transient Thermal Impedance**

**Fig.10 Switching Time Waveform**

**Fig.11 Unclamped Inductive Waveform**



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